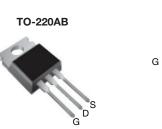
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	600			
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.75			
Q _g max. (nC)	49			
Q _{gs} (nC)	13			
Q _{gd} (nC)	20			
Configuration	Single			

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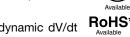




N-Channel MOSFET

FEATURES

 \bullet Low gate charge Q_{g} results in simple drive requirement



- Improved gate, avalanche and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- High speed power switching

APPLICABLE OFF LINE SMPS TOPOLOGIES

- Active clamped forward
- Main switch

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRFB9N60APbF		
Lead (Fb)-free	SiHFB9N60A-E3		
SnPb	IRFB9N60A		
SNPD	SiHFB9N60A		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage			V _{GS}	± 30	v
$T_{\rm C} = 25 ^{\circ}{\rm C}$				9.2	
Continuous Drain Current	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	I _D	5.8	А
Pulsed Drain Current ^a			I _{DM}	37	
Linear Derating Factor				1.3	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	290	mJ
Repetitive Avalanche Current ^a			I _{AR}	9.2	A
Repetitive Avalanche Energy ^a			E _{AR}	17	mJ
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	170	W
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Soldering Recommendations (Peak temperature) ^d for 10 s				300	
Mounting Torque	6.20 or 1	6.00 or M2 corous		10	lbf ∙ in
Mounting Torque	6-32 or M3 screw			1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting T_J = 25 °C, L = 6.8 mH, R_g = 25 Ω , I_{AS} = 9.2 A (see fig. 12).

c. $I_{SD} \le 9.2$ A, dI/dt ≤ 50 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

S16-0763-Rev. D, 02-May-16



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.75	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-			•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referen	ce to 25 °C, I _D = 1 mA	-	660	-	mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS}	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	Inna	V _{DS} :	= 600 V, V _{GS} = 0 V	-	-	25	μA
Zero Gate Voltage Drain Gurrent	I _{DSS}	V _{DS} = 480 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	250	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 5.5 A ^b	-	-	0.75	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 5.5 A	5.5	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	1400	-	
Output Capacitance	C _{oss}	_	V _{DS} = 25 V,	-	180	-	
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	7.1	-	pF
Output Canaditanaa	C _{oss}		V _{DS} = 1.0 V, f = 1.0 MHz	-	1957	-	
Output Capacitance		$V_{GS} = 0 V$	V _{DS} = 480 V, f = 1.0 MHz	-	49	-	
Effective Output Capacitance	Coss eff.		V _{DS} = 0 V to 480 V	-	96	-	
Total Gate Charge	Qg				-	49	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 9.2 \text{ A}, V_{DS} = 400 \text{ V}$		-	-	13	
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13 ^b		-	20	
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	t _r	V _{DD} = 300 V, I _D = 9.2 A		-	25	-	
Turn-Off Delay Time	t _{d(off)}	R_{g} = 9.1 Ω, R_{D} = 35.5 Ω, see fig. 10 ^b		-	30	-	ns
Fall Time	t _f	$m_g = 3.1 \text{ sz}, m_D = 33.3 \text{ sz}, \text{ see fig. 10}^2$		-	22	-	1
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.5	-	3.2	Ω
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.2	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	37	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = 9.2 A, V _{GS} = 0 V ^b		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 9.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^{\text{b}}$		-	530	800	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.0	4.4	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn-	-on is dor	ninated b	vleand	

Notes

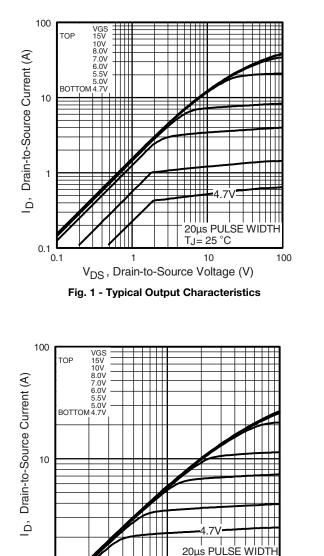
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} effective is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Tj= 150 °C

100

10

V_{DS}, Drain-to-Source Voltage (V)

Fig. 2 - Typical Output Characteristics

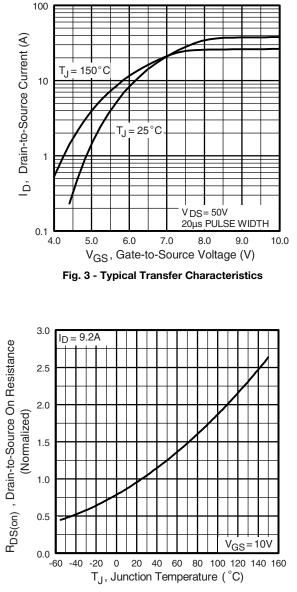


Fig. 4 - Normalized On-Resistance vs. Temperature

1



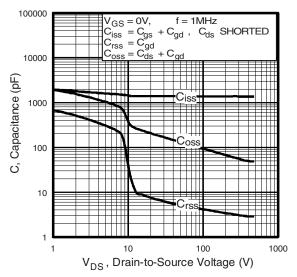


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

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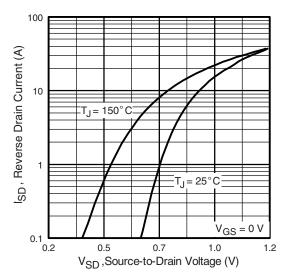


Fig. 7 - Typical Source-Drain Diode Forward Voltage

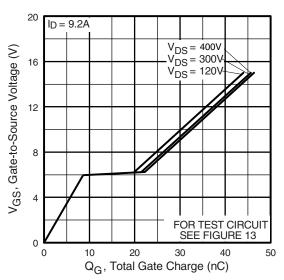


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

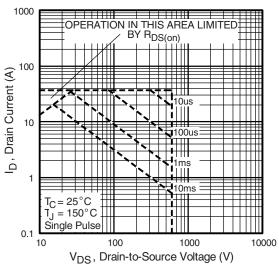


Fig. 8 - Maximum Safe Operating Area

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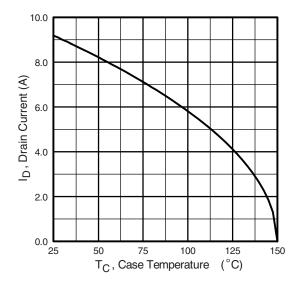


Fig. 9 - Maximum Drain Current vs. Case Temperature

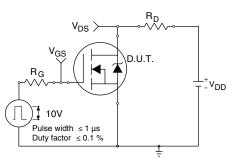


Fig. 10a - Switching Time Test Circuit

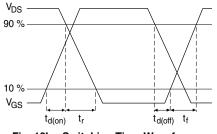


Fig. 10b - Switching Time Waveforms

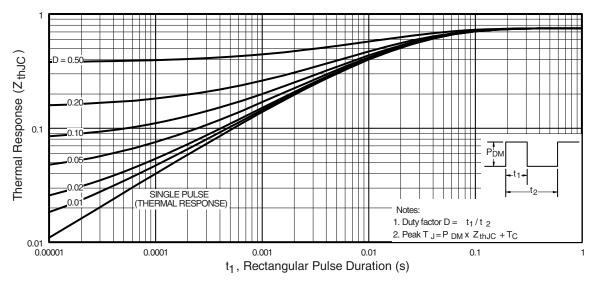
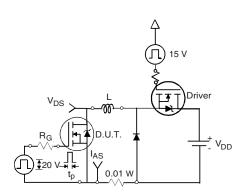


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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Fig. 12a - Unclamped Inductive Test Circuit

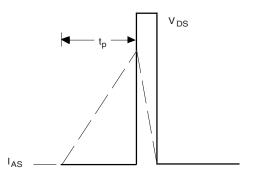


Fig. 12b - Unclamped Inductive Waveforms

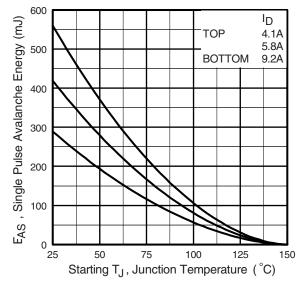
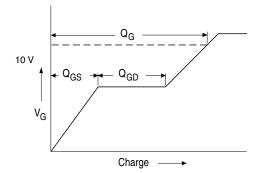
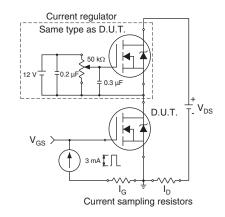


Fig. 12c - Maximum Avalanche Energy vs. Drain Current









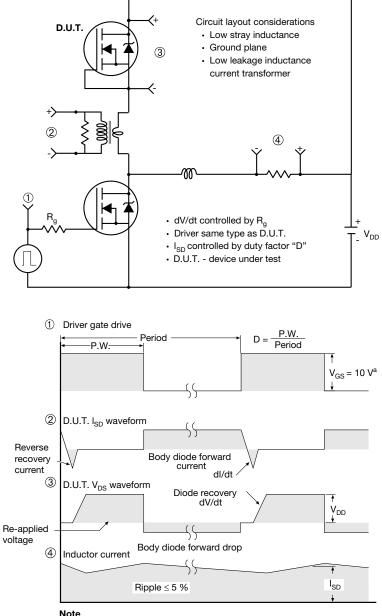
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES	
DIN.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØР	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031				

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
ASE		Xi	'an	
		IRF 9510 744K AB		

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